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SMP50 / SMTPA / TPA

Trisil™ for telecom equipment protection

Features

- Bidirectional crowbar protection
- Voltage range from 62 V to 320 V
- Low capacitance from 12 pF to 20 pF @ 50 V
- Low leakage current : I_R = 2 µA max
- Holding current: I_H = 150 mA min
- Repetitive peak pulse current : $I_{PP} = 50 \text{ A} (10/1000 \mu\text{s})$

Main applications

Telecommunication equipment such as:

- Analog and digital line cards (xDSL, T1/E1, ISDN, ...)
- Terminals (phone, fax, modem, ...) and central office equipment

Description

These Trisil series have been designed to protect telecommunication equipment against lightning and transient induced by AC power lines.

They are available in SMA, SMB and DO-15 packages.

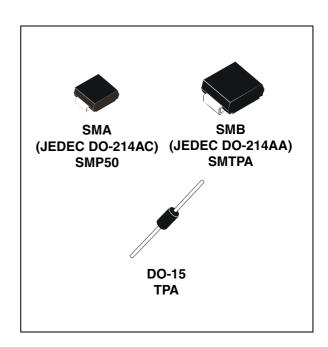
Benefits

Trisils are not subject to ageing and provide a fail safe mode in short circuit for a better protection. They are used to help equipment to meet various standards such as UL1950, IEC950 / CSA C22.2, UL1459 and FCC part 68.

Trisils have UL94 V0 approved resin. SMA and SMB packages are JEDEC registered (DO-214AC and DO-214AA).

Trisils are UL497B approved (file: E136224).

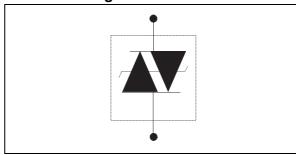
TM: TRISIL is a trademark of STMicroelectronics



Order codes

Part Number	Marking
SMP50-xxx	
TPAxxx	See Ordering Information on page 9
SMTPAxxx	7.0

Schematic Diagram



Characteristics SMP50 / SMTPA / TPA

1 Characteristics

Table 1. Compliant with the following standards

Standard	Peak Surge Voltage (V)	Waveform Voltage	Required peak current (A)	Current waveform	Minimum serial resistor to meet standard (Ω)
GR-1089 Core First level	2500 1000	2/10 μs 10/1000 μs	500 100	2/10 μs 10/1000 μs	20 10
GR-1089 Core Second level	5000	2/10 μs	500	2/10 μs	40
GR-1089 Core Intra-building	1500	2/10 μs	100	2/10 μs	0
ITU-T-K20/K21	6000 1500	10/700 μs	150 37.5	5/310 µs	53 0
ITU-T-K20 (IEC61000-4-2)	8000 15000	1/60 ns	1/60 ns ESD contact ESD air dis		0 0
VDE0433	4000 2000	10/700 μs	100 50 5/310 μs		21.5 0
VDE0878	4000 2000	1.2/50 µs	100 50	1/20 µs	0 0
IEC61000-4-5	4000 4000	10/700 μs 1.2/50 μs	100 100	5/310 μs 8/20 μs	21.5 0
FCC Part 68, lightning surge type A	1500 800	10/160 μs 10/560 μs	200 100	10/160 μs 10/560 μs	12.5 6.5
FCC Part 68, lightning surge type B	1000	9/720 μs	25	5/320 µs	0

Table 2. Absolute ratings $(T_{amb} = 25^{\circ} C)$

Symbol	Parameter	Value	Unit			
I _{PP}	Repetitive peak pulse current (see <i>Figure 1</i>)	10/1000 µs 8/20 µs 10/560 µs 5/310 µs 10/160 µs 1/20 µs 2/10 µs	50 150 55 65 75 100 100	A		
I _{FS}	Fail-safe mode : maximum current ⁽¹⁾	2.5	kA			
I _{TSM}	Non repetitive surge peak on-state current (sinusoidal)	t = 0.2 s t = 1 s t = 2 s t = 15 mn	16 11.5 10 3.5	Α		
l ² t	I ² t value for fusing	6.2 6.5	A ² s			
T _{stg} T _j	Storage temperature range Maximum junction temperature	-55 to 150 150	°C			
TL	Maximum lead temperature for soldering during 10 s. 260					

^{1.} in fail safe mode, the device acts as a short circuit

SMP50 / SMTPA / TPA Characteristics

Table 3. Thermal resistances

Symbol	Parameter		Unit		
Symbol	raiametei	DO-15	SMA	SMB	Oiiit
R _{th(j-a)}	Junction to ambient (with recommended footprint or with $L_{lead} = 10$ mm for DO-15)	100	120	100	°C/W
R _{th(j-l)}	Junction to leads (L _{lead} = 10 mm for DO-15)	60	30	20	°C/W

Table 4. Electrical characteristics - definitions ($T_{amb} = 25$ °C)

Symbol	Parameter	I _†
V _{RM}	Stand-off voltage	I _{PP} /
V _{BR}	Breakdown voltage	
V_{BO}	Breakover voltage	I _{BO}
I _{RM}	Leakage current	I _H J
I _{PP}	Peak pulse current	I _{RM} V
I _{BO}	Breakover current	V_{RM} V_{BR}
I _H	Holding current	/
V _R	Continuous reverse voltage	
I _R	Leakage current at V _R	
С	Capacitance	/

Characteristics SMP50 / SMTPA / TPA

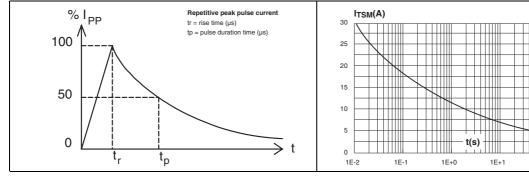
Table 5. Electrical characteristics - values ($T_{amb} = 25$ °C)

Types	I _{RM} @	V _{RM}	I _R @	V _R ⁽¹⁾	Dynamic V _{BO} ⁽²⁾		atic I _{BO} ⁽³⁾	I _H ⁽⁴⁾	C ⁽⁵⁾	C ⁽⁶⁾
	max.		max.		max.	max.	max.	min.	typ.	typ.
	μΑ	V	μΑ	V	V	٧	mA	mA	pF	pF
SMP50-62 / TPA62 SMTPA62		56		62	85	82			20	40
SMP50-68 / TPA68 SMTPA68		61		68	93	90			20	40
SMP50-100 / TPA100 SMTPA100		90		100	135	133			16	35
SMP50-120 / TPA120 SMTPA120		108		120	160	160			16	30
SMP50-130 / TPA130 SMTPA130		117		130	173	173			14	30
SMP50-180 / TPA180 SMTPA180	2	162	5	180	235	240	800	150	14	25
SMP50-200 / TPA200 SMTPA200		180		200	262	267			12	25
SMP50-220 / TPA220 SMTPA220		198		220	285	293			12	25
SMP50-240 / TPA240 SMTPA240		216		240	300	320			12	25
SMP50-270 / TPA270 SMTPA270		243		270	350	360			12	25
SMP50-320 / SMTPA320		290		320	400	400			12	25

- 1. I_R measured at V_R guarantee V_{BR} min $\geq V_R$
- 2. See functional test circuit 1(Figure 9.)
- 3. See test circuit 2(Figure 10.)
- 4. See functional holding current test circuit 3(Figure 11.)
- 5. $V_R = 50 \text{ V bias}, V_{RMS} = 1 \text{ V}, F = 1 \text{ MHz}$
- 6. $V_R = 2 V \text{ bias}, V_{RMS} = 1 V, F = 1 MHz$

Figure 1. Pulse waveform (10/1000 μs)

Figure 2. Non repetitive surge peak on-state current versus overload duration



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SMP50 / SMTPA / TPA Characteristics

Figure 3. On-state voltage versus on-state current (typical values)

Figure 4. Relative variation of holding current versus junction temperature

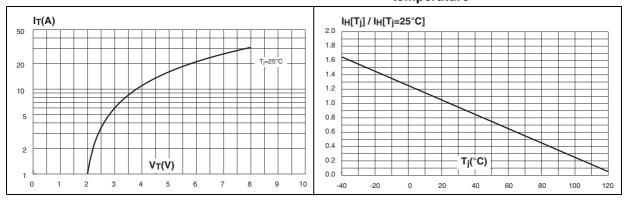


Figure 5. Relative variation of breakover voltage versus junction temperature

Figure 6. Relative variation of leakage current versus reverse voltage applied (typical values)

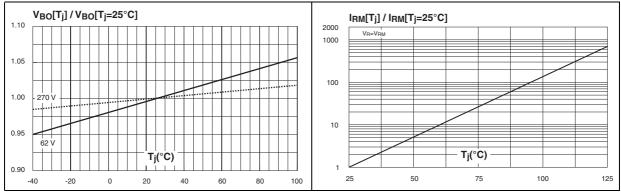
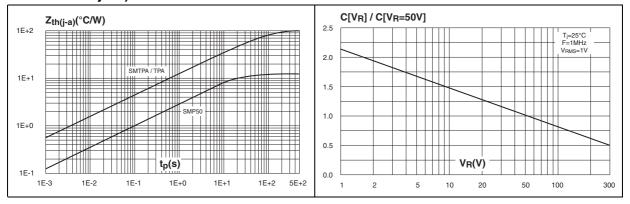


Figure 7. Variation of thermal impedance junction to ambient versus pulse duration (Printed circuit board FR4, $S_{Cu} = 35 \mu m$, recommended pad layout)

Figure 8. Relative variation of junction capacitance versus reverse voltage applied (typical values)



Characteristics SMP50 / SMTPA / TPA

Figure 9. Test circuit 1 for Dynamic $I_{\underline{BO}}$ and $V_{\underline{BO}}$ parameters

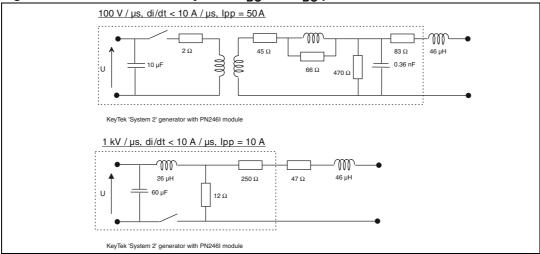


Figure 10. Test circuit 2 for I_{BO} and V_{BO} parameters

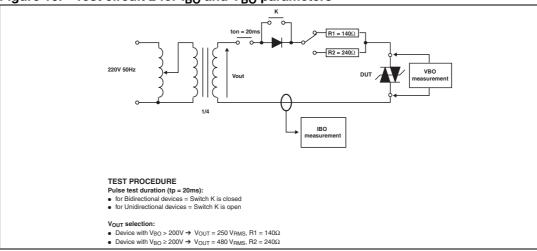
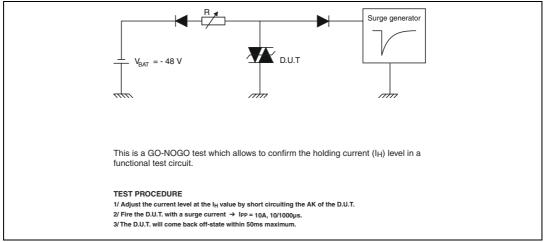
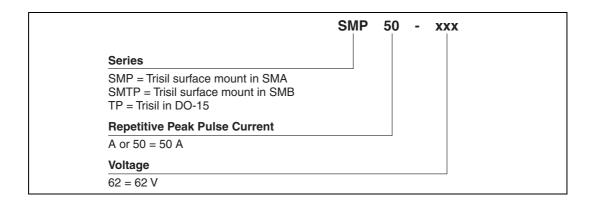


Figure 11. Test circuit 3 for dynamic I_H parameters



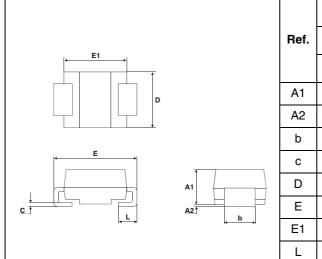
2 Ordering information scheme



3 Package information

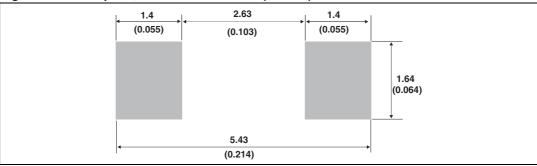
Epoxy meets UL94, V0

Table 6. SMA dimensions



		Dimer	nsions		
Ref.	Millimeters		Inc	hes	
	Min.	Max.	Min.	Max.	
A1	1.90	2.45	0.075	0.094	
A2	0.05	0.20	0.002	0.008	
d	1.25	1.65	0.049	0.065	
С	0.15	0.40	0.006	0.016	
D	2.25	2.90	0.089	0.114	
Е	4.80	5.35	0.189	0.211	
E1	3.95	4.60	0.156	0.181	
٦	0.75	1.50	0.030	0.059	

Figure 12. Footprint, dimensions in mm (inches)



Package information SMP50 / SMTPA / TPA

Table 7. SMB dimensions

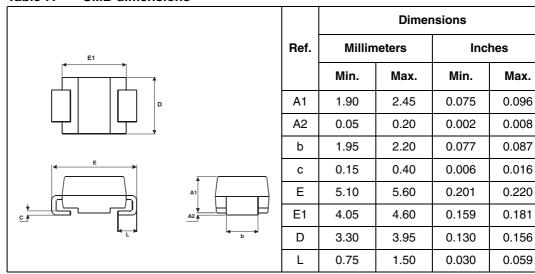


Figure 13. Footprint, dimensions in mm (inches)

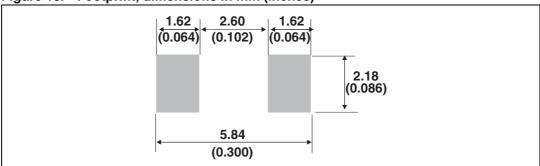
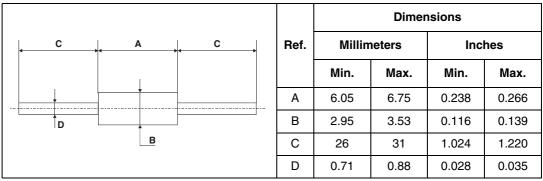


Table 8. DO-15 dimensions



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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4 Ordering Information

Part Number	Marking	Package	Weight	Base qty	Delivery mode	
SMP50-62	V06					
SMP50-68	V07					
SMP50-100	V10					
SMP50-120	V12					
SMP50-130	V13					
SMP50-180	V18	SMA	0.068 g	5000	Tape & reel	
SMP50-200	V20					
SMP50-220	V22					
SMP50-240	V24					
SMP50-270	V27					
SMP50-320	V32					
SMTPA62	U01					
SMTPA68	U05					
SMTPA100	U13					
SMTPA120	U17			2500	Tape & reel	
SMTPA130	U19					
SMTPA180	U25	SMB	0.11 g			
SMTPA200	U27					
SMTPA220	U31					
SMTPA240	U35					
SMTPA270	U39					
SMTPA320	U47					
TPA62	TDACO			1000	Ammopack	
TPA62RL	TPA62			6000	Tape & reel	
TPA68	TDAGO			1000	Ammopack	
TPA68RL	TPA68			6000	Tape & reel	
TPA100	TPA100			1000	Ammopack	
TPA100RL	1PA 100			6000	Tape & reel	
TPA120	TPA120			1000	Ammopack	
TPA130	TPA130			1000	Ammopack	
TPA130RL	1FA130			6000	Tape & reel	
TPA180	TPA180	DO-15	0.40 g	1000	Ammopack	
TPA180RL	1FA100			6000	Tape & reel	
TPA200	TP/ 200			1000	Ammopack	
TPA200RL	TPA200			6000	Tape & reel	
TPA220	TPA220			1000	Ammopack	
TPA220RL	11 AZZU			6000	Tape & reel	
TPA240	TPA240			1000	Ammopack	
TPA240RL	1 FM24U			6000	Tape & reel	
TPA270	TPA270			1000	Ammopack	
TPA270RL	117210			6000	Tape & reel	

Revision History SMP50 / SMTPA / TPA

5 Revision History

Date	Revision	Description of Changes
16-Nov-2004	1	SMP50, SMTPA and TPA datasheets merge.
30-Mar-2007	2	Reformatted to current standards. Updated I _{PP} value in Table 2 . Added part numbers SMP50-320 and SMTPA320. Updated dimensions and footprint for SMA and footprint for SMB.
12-Jun-2007	3	Corrected typographical error in part number. Added dimensions in inches to footprint illustrations.

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